Call for papers

An official publication of The Minerals, Metals & Materials Society



Publication Date: February 2021

Manuscript Deadline: September 1, 2020

Materials for High Reliability Devices

This topic invites papers that are related to high reliability devices for autonomous car or wide bandgap applications. Materials that are used for energy conversion devices are also included.

Original research papers should be 3,000-6,000 words with up to 8 figures maximum; review papers should be 6,000-10,000 words with up to 15 figures maximum.

Detailed author instructions are available at: http://www.tms.org/AuthorTools/

Keywords for this topic: Electronic Materials; Energy Conversion and Storage; Intermetallics; Mechanical Properties; Phase Transformations

Guest Editor(s): Albert T. Wu and Babak Arfaei: atwu@ncu.edu.tw; babak.arfaei@binghamton.edu

Committee Sponsor(s): Electronic Packaging and Interconnection Materials

If you are interested in submitting a paper, upload your manuscript at https://www.editorialmanager.com/jomj/

Please note that all submissions will be subject to peer review. Submission does not guarantee acceptance.

For more information on JOM, please visit jom.tms.org